

**➤ Features**

- Size 0.08\*0.05 inch /2.0\*1.2 mm
- RoHS compliant, lead-free and halogen-free
- Fast response to fault current
- Low resistance
- Low-profile
- Compatible with high temperature solders

**➤ Applications**

- Computer, Mobile phones, Multimedia
- Automotive, Industrial controls, Telephony and broadband
- Game machines, Portable electronics, Battery

**➤ Electrical Characteristics (25°C)**

Part Number	$I_{hold}$	$I_{trip}$	$V_{max}$	$I_{max}$	$P_d$	Time to trip		$R_i$	$R_{I_{max}}$
	(A)	(A)	(V)	(A)	(W)	(A)	(S)	( $\Omega$ )	( $\Omega$ )
BSMD0805L-075	0.75	1.5	6.0	50	1.0	8.0	0.3	0.009	0.070
BSMD0805L-110	1.10	2.2	6.0	50	1.0	8.0	0.5	0.008	0.065
BSMD0805L-125	1.25	2.5	6.0	50	1.0	8.0	1.0	0.007	0.060
BSMD0805L-150	1.50	3.0	6.0	50	1.0	8.0	5.0	0.006	0.055
BSMD0805L-175	1.75	3.5	6.0	50	1.0	8.0	5.0	0.005	0.050
BSMD0805L-200	2.00	4.0	6.0	50	1.0	8.0	5.0	0.004	0.045
BSMD0805L-260	2.60	5.2	6.0	50	1.0	12.0	5.0	0.003	0.035
BSMD0805L-300	3.00	6.0	6.0	50	1.0	12.0	5.0	0.003	0.030
BSMD0805L-350	3.50	7.0	6.0	50	1.0	12.0	5.0	0.002	0.025
BSMD0805L-380	3.80	7.6	6.0	50	1.0	12.0	5.0	0.002	0.020
BSMD0805L-400	4.00	8.0	6.0	50	1.2	16.0	5.0	0.001	0.018
BSMD0805L-450	4.50	9.0	6.0	50	1.2	16.0	5.0	0.001	0.015
BSMD0805L-500	5.00	10.0	6.0	50	1.2	16.0	5.0	0.001	0.012
BSMD0805L-550	5.50	11.0	6.0	50	1.5	16.0	5.0	0.0008	0.011
BSMD0805L-600	6.00	12.0	6.0	50	1.5	20.0	5.0	0.0008	0.010
BSMD0805L-650	6.50	13.0	6.0	50	1.5	20.0	5.0	0.0008	0.009
BSMD0805L-700	7.00	14.0	6.0	50	1.5	20.0	5.0	0.0005	0.009
BSMD0805L-750	7.50	15.0	6.0	50	1.6	30.0	5.0	0.0005	0.008
BSMD0805L-800	8.00	16.0	6.0	50	1.6	30.0	5.0	0.0005	0.007

**I<sub>hold</sub>** = Hold current: maximum current device will pass without tripping in 25°C still air.

**I<sub>trip</sub>** = Trip current: minimum current at which the device will trip in 25°C still air.

**V<sub>max</sub>** = Maximum voltage device can withstand without damage at rated current (I<sub>max</sub>)

**I<sub>max</sub>** = Maximum fault current device can withstand without damage at rated voltage (V<sub>max</sub>)

**P<sub>d typ.</sub>** = Typical power dissipated from device when in the tripped state at 25°C still air.

**R<sub>min</sub>** = Minimum resistance of device in initial (un-soldered) state.

**R<sub>I max</sub>** = Maximum resistance of device at 25°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

**Caution:** Operation beyond the specified ratings may result in damage and possible arcing and flame.

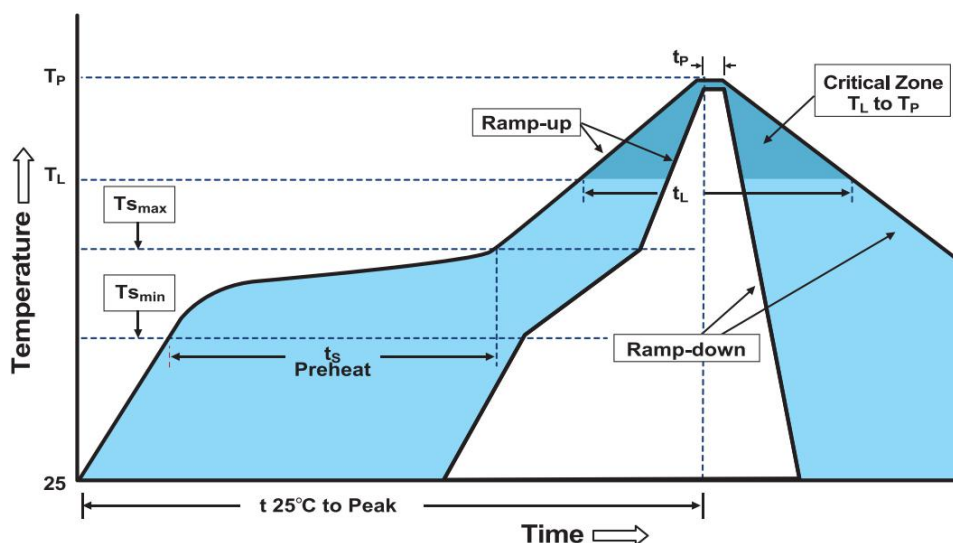
## ➤ WARNING

- Users shall independently assess the suitability of these devices for each of their applications.
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire.
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration.
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices.
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses.
- Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.

**➤ Thermal Derating Chart**

Part Number	Ambient operating temperature hold current( $I_{hold}$ )							
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C
BSMD0805L-075	1.1	1.0	0.8	0.75	0.7	0.6	0.5	0.4
BSMD0805L-110	1.7	1.4	1.2	1.10	1.0	0.8	0.7	0.6
BSMD0805L-125	1.9	1.6	1.4	1.25	1.1	0.9	0.8	0.7
BSMD0805L-150	2.3	2.0	1.7	1.50	1.4	1.1	1.0	0.9
BSMD0805L-175	2.6	2.3	1.9	1.75	1.6	1.2	1.1	1.0
BSMD0805L-200	3.0	2.6	2.2	2.00	1.8	1.4	1.3	1.2
BSMD0805L-260	3.9	3.4	2.9	2.60	2.3	1.8	1.7	1.6
BSMD0805L-300	4.5	3.9	3.3	3.00	2.7	2.1	2.0	1.8
BSMD0805L-350	5.3	4.6	3.9	3.50	3.2	2.5	2.3	2.1
BSMD0805L-380	5.7	4.9	4.2	3.80	3.4	2.7	2.5	2.3
BSMD0805L-400	6.0	5.2	4.4	4.00	3.6	2.8	2.6	2.4
BSMD0805L-450	6.8	5.9	5.0	4.50	4.1	3.2	2.9	2.7
BSMD0805L-500	7.5	6.5	5.5	5.00	4.5	3.5	3.3	3.0
BSMD0805L-550	8.3	7.2	6.1	5.50	5.0	3.9	3.6	3.3
BSMD0805L-600	9.0	7.8	6.6	6.00	5.4	4.2	3.9	3.6
BSMD0805L-650	9.8	8.5	7.2	6.50	5.9	4.6	4.2	3.9
BSMD0805L-700	10.5	9.1	7.7	7.00	6.3	4.9	4.6	4.2
BSMD0805L-750	11.3	9.8	8.3	7.50	6.8	5.3	4.9	4.5
BSMD0805L-800	12.0	10.4	8.8	8.00	7.2	5.6	5.2	4.8

➤ **Soldering Parameters**



<b>Profile Feature</b>	Pb-Free Assembly
<b>Average Ramp-Up Rate(T<sub>smax</sub> to T<sub>p</sub>)</b>	3°C/second max
<b>Preheat</b>	
-Temperature Min(T <sub>smin</sub> )	150°C
-Temperature Max(T <sub>smax</sub> )	200°C
-Time(T <sub>smin</sub> to T <sub>smax</sub> )	60~180 seconds
<b>Time maintained above:</b>	
-Temperature(T <sub>L</sub> )	217°C
-Time(t <sub>L</sub> )	60~150 seconds
<b>Peak Temperature(T<sub>p</sub>)</b>	260°C
<b>Ramp-Down Rate</b>	6°C/second max
<b>Time 25°C to Peak Temperature</b>	8 minutes max
<b>Storage Condition</b>	0°C~30°C,30%-60%RH

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Recommended maximum paste thickness is 0.25mm.
- Devices can be cleaned using standard industry methods and solvents.

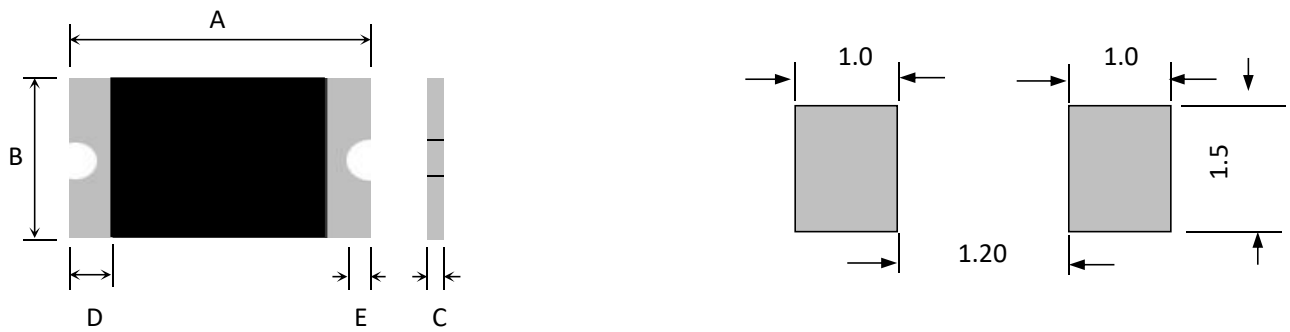
**Note 1: All temperature refer to topside of the package, measured on the package body surface.**

**Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.**

➤ **Environmental Specifications**

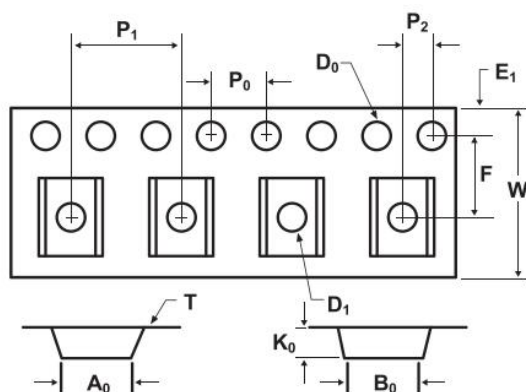
Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
<b>Ambient operating conditions : - 40 °C to +85 °C</b>		
<b>Maximum surface temperature of the device in the tripped state is 125 °C</b>		

➤ **Physical Dimensions & Recommended Pad Layout (mm)**



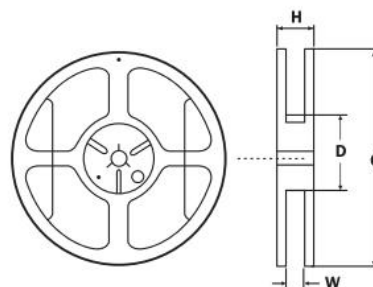
Part Number	Quantity	A		B		C		D	E
		Min	Max	Min	Max	Min	Max	Min	Min
BSMD0805L-075	4000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-110	4000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-125	4000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-150	4000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-175	4000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-200	4000	--	2.50	--	1.80	--	1.0	0.20	0.10
BSMD0805L-260	4000	--	2.50	--	1.80	--	1.0	0.20	0.10
BSMD0805L-300	4000	--	2.50	--	1.80	--	1.0	0.20	0.10
BSMD0805L-350	3000	--	2.50	--	1.80	--	1.2	0.20	0.10
BSMD0805L-380	3000	--	2.50	--	1.80	--	1.2	0.20	0.10
BSMD0805L-400	3000	--	2.50	--	1.80	--	1.2	0.20	0.10
BSMD0805L-450	3000	--	2.50	--	1.80	--	1.2	0.20	0.10
BSMD0805L-500	3000	--	2.50	--	1.80	--	1.3	0.20	0.10
BSMD0805L-550	3000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-600	3000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-650	3000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-700	3000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-750	3000	--	2.50	--	1.80	--	0.8	0.20	0.10
BSMD0805L-800	3000	--	2.50	--	1.80	--	1.0	0.20	0.10

➤ **Tape And Reel Specifications (mm)**



Governing Specifications	BSMD0805L-075~ BSMD0805L-175	BSMD0805L-200~ BSMD0805L-300	BSMD0805L-350~ BSMD0805L-800
<b>W</b>	8.0 ± 0.3	8.0 ± 0.3	8.0 ± 0.3
<b>F</b>	3.5 ± 0.05	3.5 ± 0.05	3.5 ± 0.05
<b>E1</b>	1.75 ± 0.1	1.75 ± 0.1	1.75 ± 0.1
<b>D0</b>	1.55 ± 0.05	1.55 ± 0.05	1.55 ± 0.05
<b>D1</b>	1.0 ± 0.1	1.0 ± 0.1	1.0 ± 0.1
<b>P0</b>	4.0 ± 0.1	4.0 ± 0.1	4.0 ± 0.1
<b>P1</b>	4.0 ± 0.1	4.0 ± 0.1	4.0 ± 0.1
<b>P2</b>	2.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05
<b>A0</b>	1.6 ± 0.1	1.6 ± 0.1	1.6 ± 0.1
<b>B0</b>	2.3 ± 0.1	2.3 ± 0.1	2.3 ± 0.1
<b>T</b>	0.2 ± 0.1	0.2 ± 0.1	0.2 ± 0.1
<b>K0</b>	0.74 ± 0.1	1.04 ± 0.1	1.35 ± 0.1
<b>Leader</b> min	390	390	390
<b>Trailer</b> min	160	160	160

Reel Dimensions	
<b>C</b>	φ178 ± 1.0
<b>D</b>	φ60.2 ± 0.5
<b>H</b>	11.0 ± 0.5
<b>W</b>	9.0 ± 1.5



➤ **Contact information**

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